Supporting Information for

Free-Standing 3D Nitrogen-Carbon Anchored Cu Nanorod Arrays: *In-Situ* Derivation from Metal-Organic Framework and Strategy to Stabilize Lithium Metal Anode

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Figure S1. TG curve of Cu-MOF.



Figure S2. Digital photos of (a) Cu foil, (b) Cu-MOF and (c) NC/Cu.



Figure S3. Cross-sectional SEM images of (a) Cu-MOF and (b) NC/Cu.



Figure S4. XRD patterns of Cu foil, Cu-TCNQ, Cu-MOF@Cu foil and NC/Cu.



Figure S5. (a) TEM image, (b) HRTEM image, (c) SAED pattern, (d) HAADF-STEM image and (e-g) element mapping of NC/Cu.



Figure S6. (a) N_2 adsorption-desorption isotherms and (b) pore size distribution curves of NC/Cu current collector.



Figure S7. XPS spectra of (a) NC-Cu, (b) C 1s, (c) N 1s, and (d) Cu 2p. Note that the presence of O in (a) may result from the absorption of water molecules and oxygen in air.



Figure S8. XRD pattern of NC/Cu electrode after lithium deposition.



Figure S9. (a) Top view and (b) cross-sectional SEM images of lithium on Li-Cu electrode. Inset in (a) and (b) are the SEM image of Cu foil and the digital photo of Li-Cu electrode.



Figure S10. Voltage *vs.* capacity profiles of Li stripping/plating on Cu current collector at different cycles with a current density of 0.5 mA cm⁻² for the areal capacity of 2 mAh cm⁻².



Figure S11. (a) Coulombic efficiencies of the cells using NC/Cu current collectors at 1, 2 and 5 mA cm⁻². (b) The 10th voltage *vs.* capacity profiles of Li stripping/plating on NC/Cu current collectors with a specific capacity of 1 mAh cm⁻² and current densities of 1, 2 and 5 mA cm⁻².



Figure S12. (a) Top view and (b) cross-sectional SEM images of Cu foil current collector after lithium deposition at the 50th cycle.



Figure S13. Comparative Nyquist plots of Li stripping/plating on NC/Cu and Cu foil current collectors (a) before cycle, (b) after the 50th cycles at 0.5 mA cm⁻² with the capacity of 2 mAh cm⁻².



Figure S14. The voltage vs. time profiles of the Li-NC/Cu symmetric cell at different current densities.



Figure S15. SEM images of (a) Cu foil at TCNQ acetonitrile solution for 12 h, (b) the corresponding cross-sectional image, (c) NC/Cu-12 and (d) NC/Cu-12 deposited with 2 mAh cm⁻² of Li.



Figure S16. SEM images of NC/Cu deposited with (a) 0.2 and (b) 0.5 mAh cm⁻² of Li.



Figure S17. Cycling performance of Li-NC/CulLFP full cell at 0.5 C.



Figure S18. The discharge-charge capacities and corresponding CEs of the NC/Cu || LFP and Cu foil || LFP cells at 0.2 C.